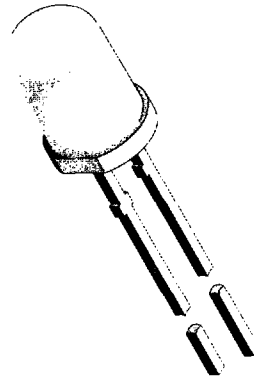


GaAs Infrared Emitting Diodes in $\varnothing 5$ mm (T-1 $\frac{3}{4}$) Package

Description

TSUS520. series are infrared emitting diodes in standard GaAs on GaAs technology, molded in a clear, blue-grey tinted plastic package. The devices are spectrally matched to silicon photodiodes and phototransistors.



94 8390

Features

- Low cost emitter
- Low forward voltage
- High radiant power and radiant intensity
- Suitable for DC and high pulse current operation
- Standard T-1 $\frac{3}{4}$ ($\varnothing 5$ mm) package
- Angle of half intensity $\varphi = \pm 15^\circ$
- Peak wavelength $\lambda_p = 950$ nm
- High reliability
- Good spectral matching to Si photodetectors

Applications

Infrared remote control and free air transmission systems with low forward voltage and low cost requirements in combination with PIN photodiodes or phototransistors.

Absolute Maximum Ratings

$T_{amb} = 25^\circ\text{C}$

| Parameter | Test Conditions | Symbol | Value | Unit |
|-------------------------------------|--|------------|------------|------------------|
| Reverse Voltage | | V_R | 5 | V |
| Forward Current | | I_F | 150 | mA |
| Peak Forward Current | $t_p/T=0.5, t_p=100 \mu\text{s}$ | I_{FM} | 300 | mA |
| Surge Forward Current | $t_p=100 \mu\text{s}$ | I_{FSM} | 2.5 | A |
| Power Dissipation | | P_V | 210 | mW |
| Junction Temperature | | T_j | 100 | $^\circ\text{C}$ |
| Operating Temperature Range | | T_{amb} | -55...+100 | $^\circ\text{C}$ |
| Storage Temperature Range | | T_{stg} | -55...+100 | $^\circ\text{C}$ |
| Soldering Temperature | $t \leq 5\text{sec}, 2 \text{ mm from case}$ | T_{sd} | 260 | $^\circ\text{C}$ |
| Thermal Resistance Junction/Ambient | | R_{thJA} | 375 | K/W |

Basic Characteristics

$T_{amb} = 25^{\circ}\text{C}$

| Parameter | Test Conditions | Symbol | Min | Typ | Max | Unit |
|----------------------------------|---|------------------|-----|----------|-----|---------------|
| Forward Voltage | $I_F = 100\text{ mA}$, $t_p = 20\text{ ms}$ | V_F | | 1.3 | 1.7 | V |
| Temp. Coefficient of V_F | $I_F = 100\text{ mA}$ | TK_{V_F} | | -1.3 | | mV/K |
| Reverse Current | $V_R = 5\text{ V}$ | I_R | | | 100 | μA |
| Junction Capacitance | $V_R = 0\text{ V}$, $f = 1\text{ MHz}$, $E = 0$ | C_j | | 30 | | pF |
| Temp. Coefficient of ϕ_c | $I_F = 20\text{ mA}$ | TK_{ϕ_c} | | -0.8 | | %/K |
| Angle of Half Intensity | | ϕ | | ± 15 | | deg |
| Peak Wavelength | $I_F = 100\text{ mA}$ | λ_p | | 950 | | nm |
| Spectral Bandwidth | $I_F = 100\text{ mA}$ | $\Delta\lambda$ | | 50 | | nm |
| Temp. Coefficient of λ_p | $I_F = 100\text{ mA}$ | TK_{λ_p} | | 0.2 | | nm/K |
| Rise Time | $I_F = 100\text{ mA}$ | t_r | | 800 | | ns |
| | $I_F = 1.5\text{ A}$ | t_r | | 400 | | ns |
| Fall Time | $I_F = 100\text{ mA}$ | t_f | | 800 | | ns |
| | $I_F = 1.5\text{ A}$ | t_f | | 400 | | ns |

Type Dedicated Characteristics

$T_{amb} = 25^{\circ}\text{C}$

| Parameter | Test Conditions | Type | Symbol | Min | Typ | Max | Unit |
|-------------------|---|---------------|----------|-----|-----|-----|-------|
| Forward Voltage | $I_F = 1.5\text{ A}$, $t_p = 100\mu\text{s}$ | TSUS5200/5201 | V_F | | 2.2 | 3.4 | V |
| | | TSUS5202 | V_F | | 2.2 | 2.7 | V |
| Radiant Intensity | $I_F = 100\text{ mA}$, $t_p = 20\text{ ms}$ | TSUS5200 | I_e | 10 | 20 | | mW/sr |
| | | TSUS5201 | I_e | 15 | 25 | | mW/sr |
| | | TSUS5202 | I_e | 20 | 30 | | mW/sr |
| Radiant Intensity | $I_F = 1.5\text{ A}$, $t_p = 100\mu\text{s}$ | TSUS5200 | I_e | 95 | 180 | | mW/sr |
| | | TSUS5201 | I_e | 120 | 230 | | mW/sr |
| | | TSUS5202 | I_e | 170 | 280 | | mW/sr |
| Radiant Power | $I_F = 100\text{ mA}$, $t_p = 20\text{ ms}$ | TSUS5200 | ϕ_e | | 13 | | mW |
| | | TSUS5201 | ϕ_e | | 14 | | mW |
| | | TSUS5202 | ϕ_e | | 15 | | mW |

Typical Characteristics ($T_{amb} = 25^{\circ}\text{C}$ unless otherwise specified)

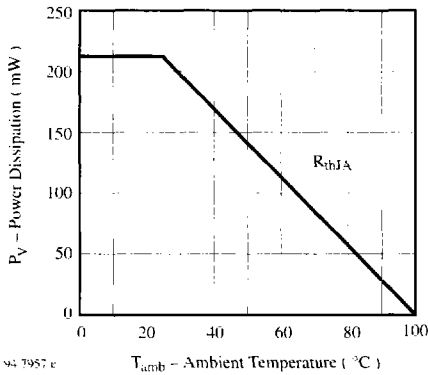


Figure 1. Power Dissipation vs. Ambient Temperature

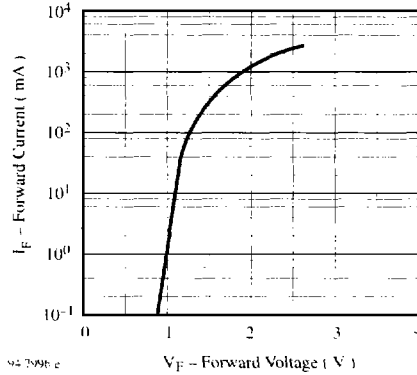


Figure 4. Forward Current vs. Forward Voltage

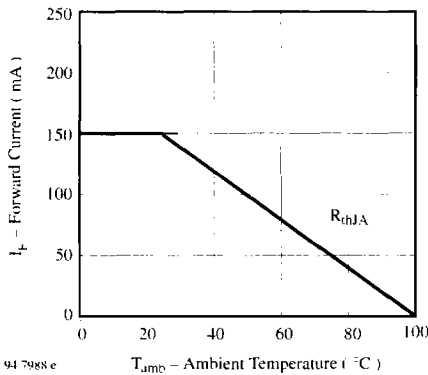


Figure 2. Forward Current vs. Ambient Temperature

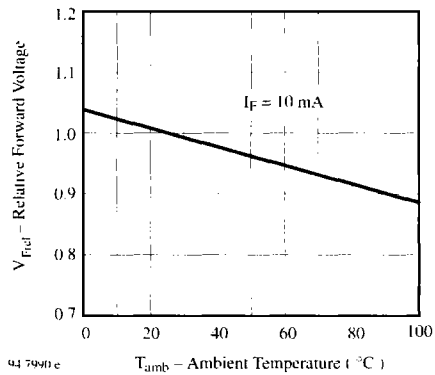


Figure 5. Relative Forward Voltage vs. Ambient Temperature

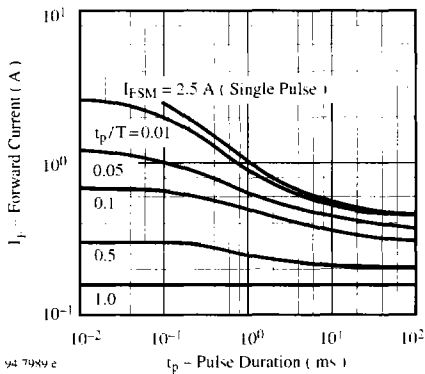


Figure 3. Pulse Forward Current vs. Pulse Duration

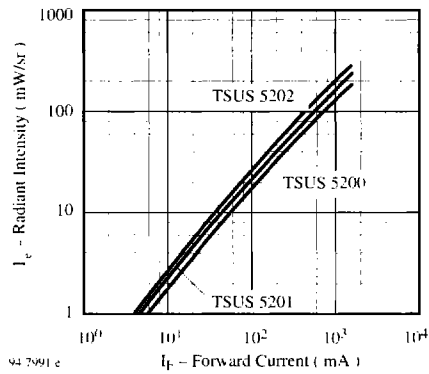


Figure 6. Radiant Intensity vs. Forward Current

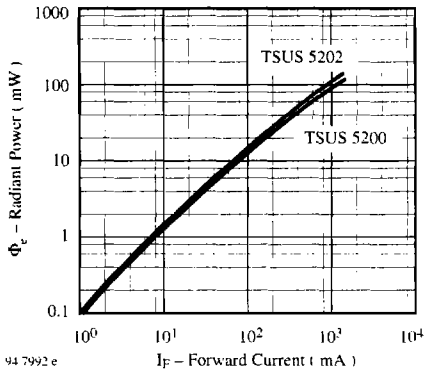


Figure 7. Radiant Power vs. Forward Current

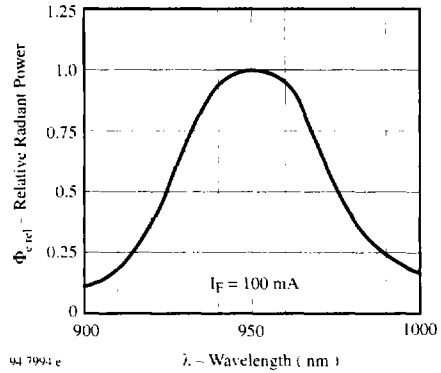


Figure 9. Relative Radiant Power vs. Wavelength

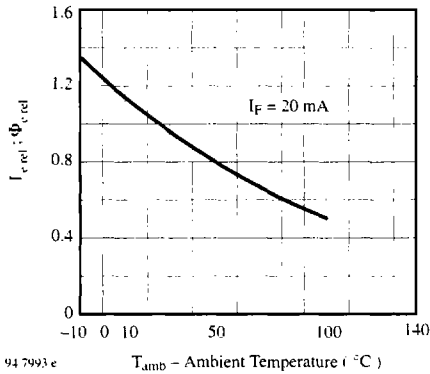


Figure 8. Rel. Radiant Intensity/Power vs. Ambient Temperature

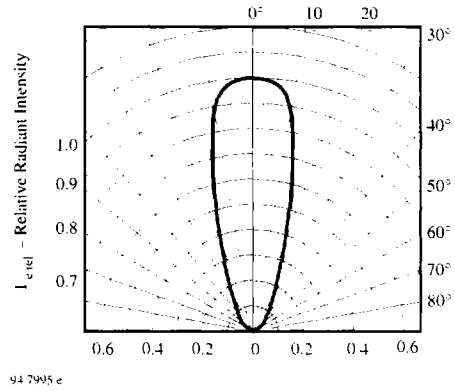
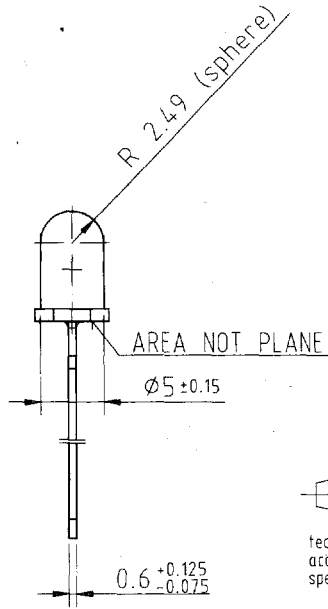
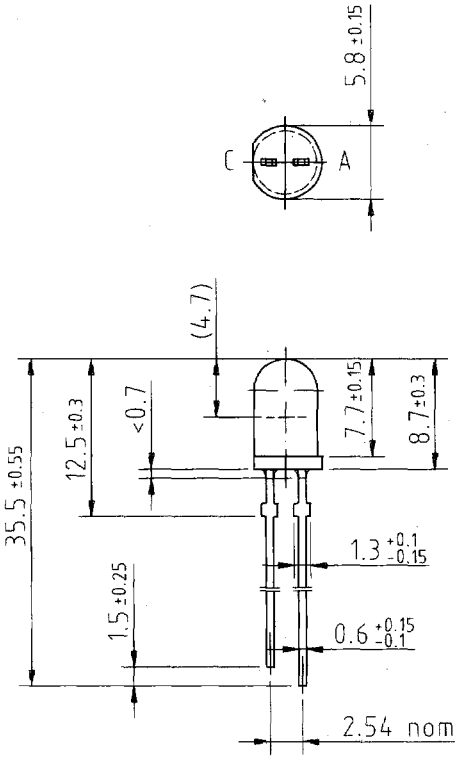


Figure 10. Relative Radiant Intensity vs. Angular Displacement

Dimensions in mm

95 10916



technical drawings
according to DIN
specifications